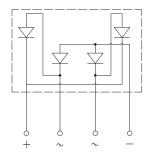






Low VF Bridge Rectifiers





Features

- UL recognition, file #E230084
- Glass passivated chip junction
- Thin single in-line package
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

General purpose use in AC/DC bridge full wave rectification for switching power supply, home appliances, office equipment, industrial automation applications.

Mechanical Data

• Package: 6KBJ

Molding compound meets UL 94 V-0 flammability

rating, RoHS-compliant

• **Terminals**: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

• Polarity: As marked on body

■Maximum Ratings (T_a=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	GBJL1508S
Device marking code				GBJL1508S
Maximum Repetitive Peak Reverse Voltage		VRRM	V	800
Maximum RMS Voltage		VRMS	V	560
Maximum DC blocking Voltage		VDC	V	800
Average rectified output current @60Hz sine wave, R-load	With heatsink Tc =110°C	lo.	А	15.0
	Without heatsink Ta =25℃	lo		3.0
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C		- IFSM	А	350
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C				700
Current squared time @1ms≤t≤8.3ms Tj=25°C, Rating of per diode		l²t	A ² s	508
Storage temperature		T _{stg}	°C	-55 ~ +150
Junction temperature		Tj	°C	-55 ~ +150
Dielectric strength @ Terminals to case, AC 1 minute		Vdis	KV	2.5
Mounting torque @Recommend torque: 5kg·cm		Tor	kg∙cm	8

GBJL1508S

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GBJL1508S
Maximum instantaneous forward voltage drop per diode	VF	V	IFM=7.5A	0.92
Maximum DC reverse current at rate DC blocking voltage per diode	IR	μА	T _j =25℃	5
			T _j =125°C	100
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	90

■Thermal Characteristics $(T_a=25^{\circ}\mathbb{C} \text{ Unless otherwise specified})$

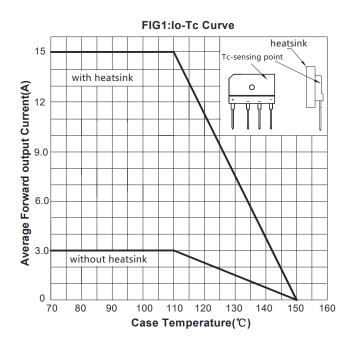
PARAMETER		SYMBOL	UNIT	GBJL1508S
Typical Thermal Resistance	Between junction and ambient, Without heatsink	$R_{\theta J-A}$	°C/W	20
	Between junction and case, With heatsink	$R_{ heta J-C}$		1.5

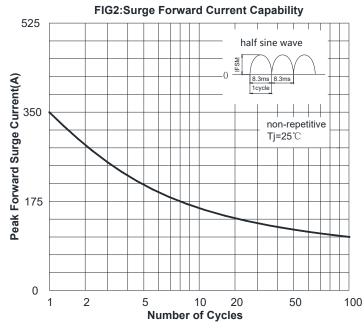
Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GBJL1508S	B1	Approximate 6.5	15	750	1500	TUBE

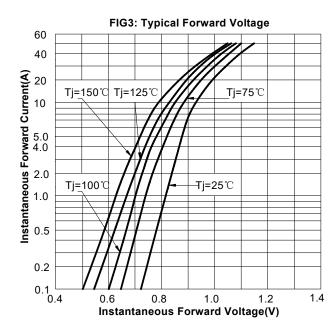
■ Characteristics(Typical)

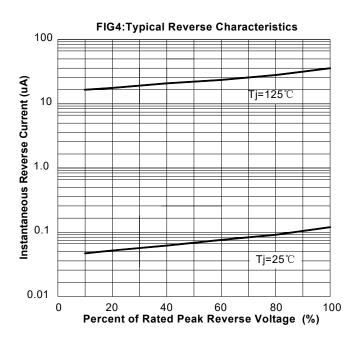




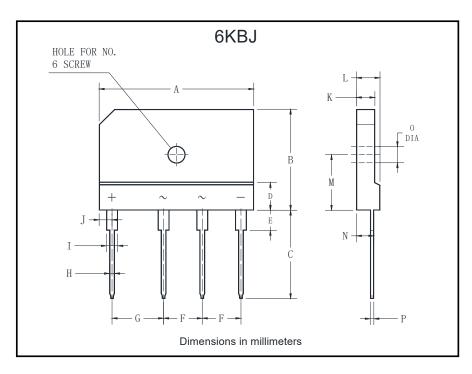








■ Outline Dimensions



6KBJ							
Dim	Min	Max					
Α	29.7	30.3					
В	19.7	20.3					
С	17.0	18.0					
D	4.8	5.8					
E	3.8	4.2					
F	7.3	7.7					
G	9.8	10.2					
Н	0.9	1.1					
I	2.0	2.4					
J	2.3	2.7					
K	3.4	3.8					
L	4.4	4.8					
М	10.8	11.2					
N	3.1	3.7					
0	3.1	3.4					
Р	0.6	0.8					



GBJL1508S

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